

**U.S. UTILITY Patent Application**

**PATENT NUMBER and  
ISSUE DATE**

<b>APPL NUM</b> 10079517	<b>FILING DATE</b> 02/22/2002	<b>CLASS</b> 148	<b>SUBCLASS</b> 525	<b>GAU</b> 1742	<b>EXAMINER</b> Wyszomierski
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**\*\*APPLICANTS:** Ngo Minh;

**\*\*CONTINUING DATA VERIFIED:**

**\*\* FOREIGN APPLICATIONS VERIFIED:**

<b>PG-PUB</b>	<b>DO NOT PUBLISH</b> <input checked="" type="checkbox"/>	<b>RESCIND</b> <input type="checkbox"/>	<b>ATTORNEY DOCKET NO</b> 50432-234
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no		35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no	
Verified and Acknowledged Examiners's initials			
<b>TITLE :</b> Method of forming nitride capped Cu lines with improved adhesion and reduced electromigration along the Cu/nitride interface			

U.S. DEPT. OF COMM./PAT. & TM.-PTO-438L (Rev. 12-94)

<b>NOTICE OF ALLOWANCE MAILED</b>		<b>CLAIMS ALLOWED</b>		
		Total Claims	Print Claim for O.G.	
<b>ISSUE FEE</b>		<b>DRAWING</b>		
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.	Print Fig.
		<b>Application Examiner</b>		
<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>		<b>PREPARED FOR ISSUE</b>		
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